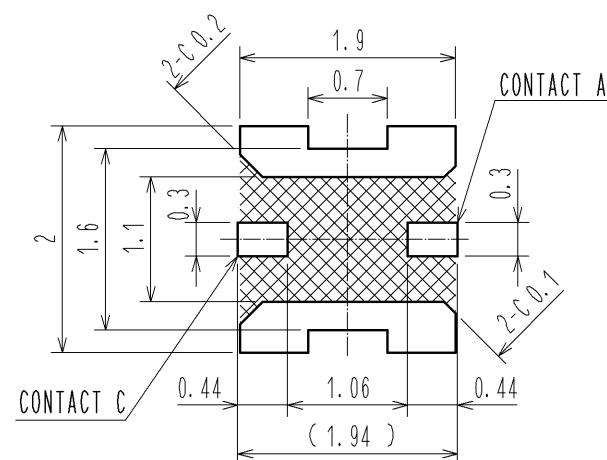



5 SPECIFIED PCB LAYOUT

The dimensional tolerance to be ± 0.05 .

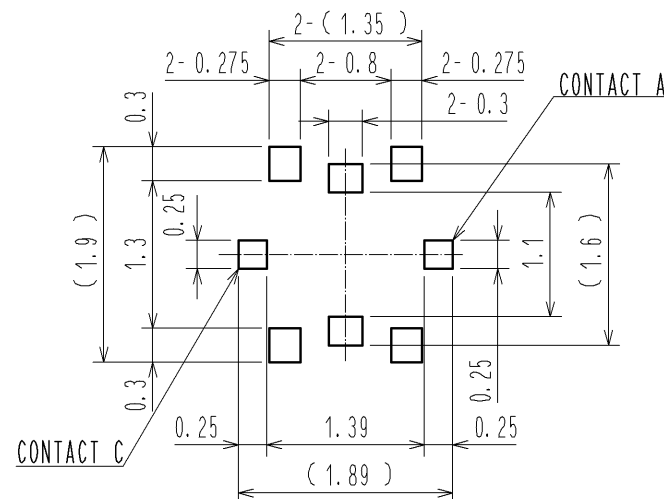


: This area must be free of conductive traces and resist field.

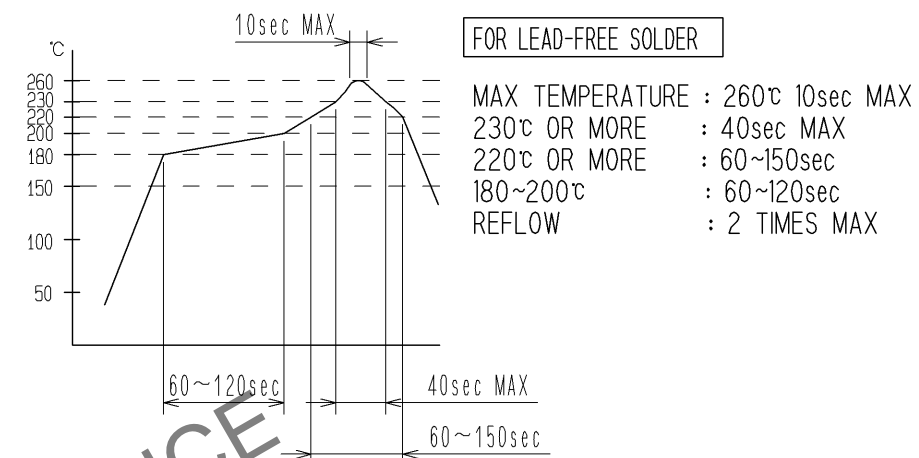
5 SPECIFIED STENCIL PLATE

THICKNESS: 0.1mm

The dimensional tolerance to be ± 0.05 .

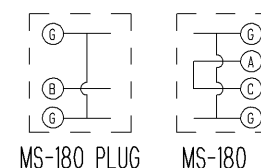


RECOMMENDED REFLOW TEMPERATURE PROFILE

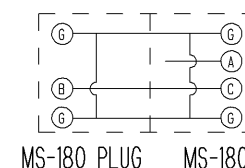


NOTE 1. Circuit shall be as follows.




STATE OF CONTACT UNMATED








STATE OF CONTACT MATED



2. For use of this product, be sure to put contact area of plug on position P perpendicularly.
3. Lead co-planarity is to be 0.08mm MAX.
4. Do not use the washing process.
5. Please do not change the specified layout of the PCB dimension and the layout of the stencil plate dimension and thickness otherwise could not be responsible for the solderability of the product.
6. This product is intended to be used for circuit inspection only. Consult us if any other application is considered.
7. Do not use hand soldering for mounting of MS-180.

3	CU-NI-SI-ALLOY	SELECTIVE GOLD PLATING	7	PS	
2	LCP-M 		6	PS	
2	LCP-M 		5	PS	
1	BRASS	SELECTIVE GOLD PLATING 	4	CU-NI-SI-ALLOY	SELECTIVE GOLD PLATING
NO.	MATERIAL	FINISH , REMARKS	NO.	MATERIAL	FINISH , REMARKS

UNITS mm		SCALE 15 : 1	COUNT  2	DESCRIPTION OF REVISIONS DIS-J-001356	DESIGNED TS. NAKAGAWA	CHECKED NK. NINOMIYA	DATE 11. 09. 1
APPROVED : KJ. KAWAMURA 08. 11. 08				DRAWING NO.	EDC3-180771-00		
CHECKED : TY. OZAKI 08. 11. 07				PART NO.	MS-180		
DESIGNED : TS. NAKAGAWA 08. 11. 07				CODE NO.	CL358-0265-7-00		
DRAWN : TS. NAKAGAWA 08. 11. 07							



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